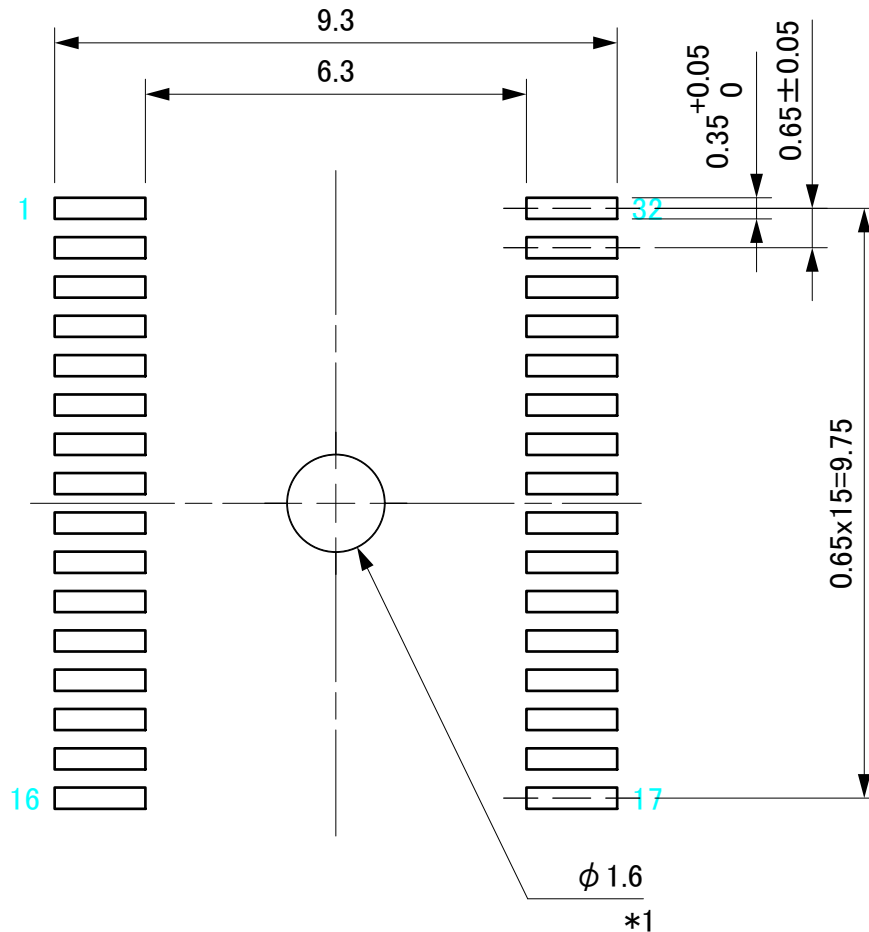


Recommended a Foot pattern of NSPACK32BK (-SL)



NOTE

- *1. Non-through hole is requested when using NSPACK32BK-SL type.
- * 2. Recommended foot pattern shown on above is for NSPACK soldering.
But please refer to IC package foot pattern recommended by IC manufacturer also, when the package is soldered on the same foot pattern.
- *3. Tolerance: ± 0.1

Part No.	NSPACK32BK
IC package	Rectangle
Pin count	32
Lead pitch	0.65
Unit	mm
Design / Date	M.Miura / Jul.18.'07
TET TOKYO ELETECH CORP.	